L Number	Hits	Search Text	DB	Time stamp
-	1	73/862.08-862.195.ccls. and (83.clas. or 225.clas. or 30.clas.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/26 10:03
-	6	(((force or strain or load) near (sens$4 or gauge or detect$4)) near11 handle) and (83.clas. or 225.clas. or 30.clas.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/26 10:14
-	0	(((force or strain or load) near (sens$4 or gauge or detect$4)) near11 handle) and (83.clas. or 225.clas. or 30.clas.)	USOCR	2004/10/26 10:07
-	20	("1388131" | "1641153" | "2556725" | "2618993" | "2704472" | "2729995" | "2737071" | "2786378" | "2800042" | "3059511" | "3272002" | "3330148" | "4132107" | "4144737" | "4158302" | "4240280" | "4342216" | "4403531" | "4581894" | "4604890").PN.	USPAT	2004/10/26 10:10
-	11	((force or strain or load) near (sens$4 or gauge or detect$4)) and 225.clas.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/26 10:27
-	2	((force or strain or load) near (sens$4 or gauge or detect$4)) and 225.clas.	USOCR	2004/10/26 10:18
-	17	((force or strain or load) near (sens$4 or gauge or detect$4 or measur$4)) and 225.clas.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/26 10:31
-	309	(force or strain or load) and 225/96.5.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/26 10:30
-	14	((force or strain or load) near11 (sens$4 or gauge or detect$4 or measur$4)) and 225/96.5.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/26 10:51
-	4	((force or strain or load) near11 (sens$4 or gauge or detect$4 or measur$4)) and 225/96.5.ccls.	USOCR	2004/10/26 11:02
-	4	("2534756").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/26 10:39
-	1	2534756.URPN.	USPAT	2004/10/26 10:39
-	16	(("0140426") or ("0419018") or ("0494921") or ("1344533") or ("1344562") or ("1656104")).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/26 10:45
-	106	225/96.5.ccls. and handle	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/26 13:33
-	41	((force or strain or load) near11 (sens$4 or gauge or detect$4 or measur$4)) and 438/460-465.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/26 10:54
-	114	glass and 225/96.5.ccls.	USOCR	2004/10/26 11:10

-	570	(225/96.5).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/26 11:10
-	52	225/96.5.ccls. and semiconductor	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/26 13:45
-	6	225/96.5.ccls. and semiconductor	USOCR	2004/10/26 13:40
-	0	81/467,479	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/26 13:45
-	386	(81/467,479).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/26 13:45